BAS40LP

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Leadless Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: Cathode Dot
- Terminals: Finish NiPdAu annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.001 grams (approximate)

Bottom View

Maximum Ratings $@T_A = 25$ °C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
Forward Continuous Current	I _{FM}	200	mA
Forward Surge Current @ t < 1.0s	I _{FSM}	600	mA

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation	PD	250	mW
Thermal Resistance, Junction to Ambient Air	$R_{ ext{ heta}JA}$	400	°C/W
Operating Temperature Range	TJ	-55 to +125	۵°
Storage Temperature Range	T _{STG}	-65 to +150	°C

Electrical Characteristics $@T_A = 25$ °C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	V _{(BR)R}	40		_	V	I _R = 10μA
Forward Voltage (Note 3)	VF	_	_	380 1000		t _p < 300μs, I _F = 1.0mA t _p < 300μs, I _F = 40mA
Reverse Leakage Current (Note 3)	I _R	_	20	200	nA	$t_p < 300 \mu s, V_R = 30 V$
Total Capacitance	CT	_	2.3	5.0	pF	$V_R = 0V$, f =1.0MHz
Reverse Recovery Time	t _{rr}	_		5.0		$I_F = I_R = 10$ mA to $I_R = 1.0$ mA, $R_L = 100\Omega$

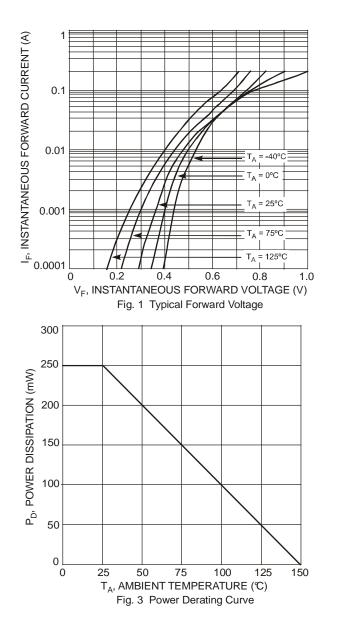
1. No purposefully added lead.

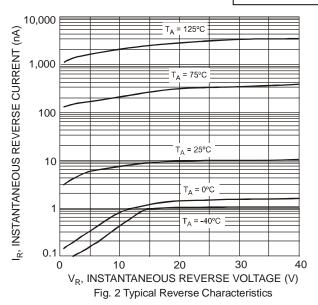
Notes:

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

3. Short duration pulse test used to minimize self-heating effect.

BAS40LP





Ordering Information (Note 4)

Part Number	Case	Packaging
BAS40LP-7	DFN1006-2	3000/Tape & Reel

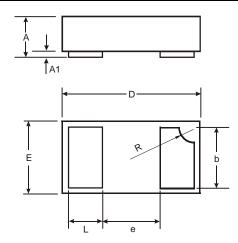
Notes: 4. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

• 43

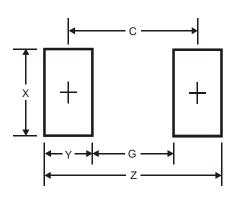
43 = Product Type Marking Code Dot Denotes Cathode Side

Package Outline Dimensions



DFN1006-2				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0	0.05	0.03	
b	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Е	0.55	0.675	0.60	
е		_	0.40	
L	0.20	0.30	0.25	
R	0.05	0.15	0.10	
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.1
G	0.3
Х	0.7
Y	0.4
C	0.7

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.